

MP6K31-VB Datasheet Dual N-Channel 60 V (D-S) 175 °C MOSFET

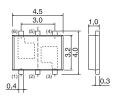
PRODUCT SUMMARY				
V _{DS} (V)	60			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$	0.033			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 4.5 \text{ V}$	0.045			
I _D (A) per leg	7			
Configuration	Dual			

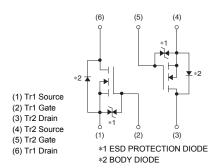
FEATURES

- Trench power MOSFET
- \bullet 100 % R_g and UIS tested



Dimensions (Unit : mm)





ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-Source Voltage		V _{DS}	60	V		
Gate-Source Voltage		V_{GS}	± 20	V		
Continuous Drain Current	T _C = 25 °C	I _D	7			
	T _C = 125 °C		4			
Continuous Source Current (Diode Conduction) ^a		I _S	3.6	Α		
Pulsed Drain Current ^b		I _{DM}	28			
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	18			
Single Pulse Avalanche Energy	L = 0.1 IIII	E _{AS}	16.2	mJ		
Maximum Power Dissipation ^b	T _C = 25 °C	Б	4	W		
	T _C = 125 °C	P_{D}	1.3	VV		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +175	°C		

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-Ambient	PCB Mount ^c	R_{thJA}	110	°C/W	
Junction-to-Foot (Drain)		R_{thJF}	34	G/VV	

Notes

- a. Package limited.
- b. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- c. When mounted on 1" square PCB (FR4 material).



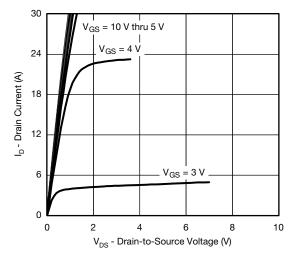
PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		60	-	-	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		1.5	2.0	2.5	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
Zero Gate Voltage Drain Current		V _{GS} = 0 V	V _{DS} = 60 V	-	-	1	μA
	I _{DSS}	$V_{GS} = 0 V$	$V_{DS} = 60 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$	ı	-	50	
		$V_{GS} = 0 V$	$V_{DS} = 60 \text{ V}, T_{J} = 175 ^{\circ}\text{C}$	-	-	150	
On-State Drain Current ^a	I _{D(on)}	$V_{GS} = 10 \text{ V}$	$V_{DS} \ge 5 V$	20	-	-	Α
Drain-Source On-State Resistance a		V _{GS} = 10 V	$I_D = 4.5 A$	ı	0.033	-	Ω
	R _{DS(on)}	$V_{GS} = 10 \text{ V}$	$I_D = 4.5 \text{ A}, T_J = 125 ^{\circ}\text{C}$	-	0.066	-	
	1 (DS(on)	V _{GS} = 10 V	I _D = 4.5 A, T _J = 175 °C	-	0.081	-	
		$V_{GS} = 4.5 \text{ V}$	$I_D = 4 A$	-	0.045	-	
Forward Transconductance f	g _{fs}	$V_{DS} = 15 \text{ V}, I_D = 4.5 \text{ A}$		-	15	-	S
Dynamic ^b							
Input Capacitance	C _{iss}		V _{DS} = 25 V, f = 1 MHz	-	600	750	pF
Output Capacitance	Coss	V _{GS} = 0 V		-	110	140	
Reverse Transfer Capacitance	C _{rss}			-	50	62	
Total Gate Charge ^c	Qg	V _{GS} = 10 V	V _{DS} = 30 V, I _D = 5.3 A	-	11.7	18	nC
Gate-Source Charge ^c	Q _{gs}			-	1.8	2.7	
Gate-Drain Charge ^c	Q _{gd}			-	2.8	4.2	
Gate Resistance	R_g	f = 1 MHz		1.3	-	6	Ω
Turn-On Delay Time ^c	t _{d(on)}	$V_{DD} = 30 \text{ V}, \text{ R}_L = 6.8 \Omega$ $I_D \cong 4.4 \text{ A}, \text{ V}_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega$		1	7	11	
Rise Time ^c	t _r			1	3.3	5	ns
Turn-Off Delay Time ^c	t _{d(off)}			-	22.4	33.5	
Fall Time ^c	t _f			-	2.1	3.2	
Source-Drain Diode Ratings and Chara	acteristics b						
Pulsed Current ^a	I _{SM}			-	_	28	Α
Forward Voltage	V _{SD}	I _F = 2 A, V _{GS} = 0 V		-	0.75	1.1	V

Notes

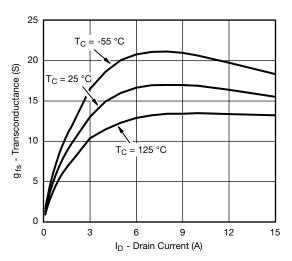
- a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.



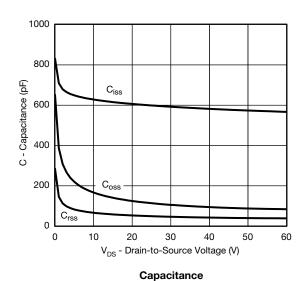
TYPICAL CHARACTERISTICS ($T_A = 25 \, ^{\circ}\text{C}$, unless otherwise noted)

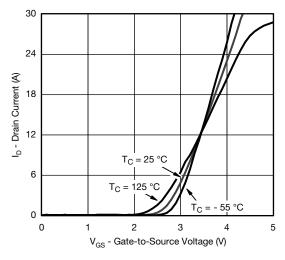


Output Characteristics

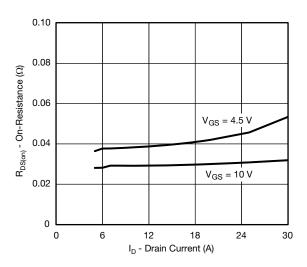


Transconductance

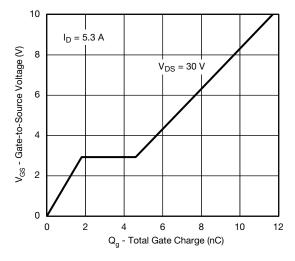




Transfer Characteristics



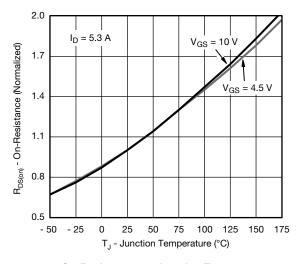
On-Resistance vs. Drain Current



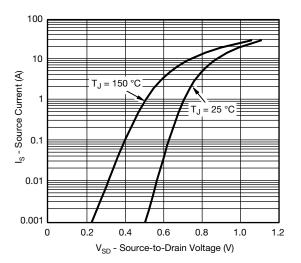
Gate Charge



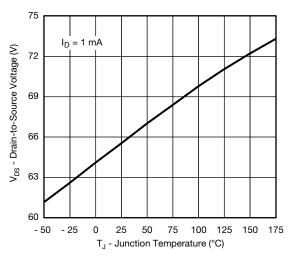
TYPICAL CHARACTERISTICS ($T_A = 25 \, ^{\circ}\text{C}$, unless otherwise noted)



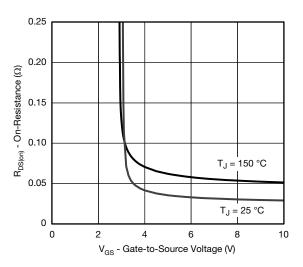
On-Resistance vs. Junction Temperature



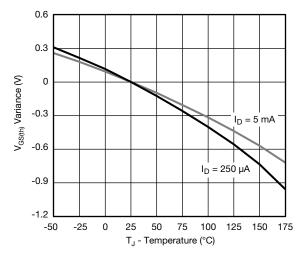
Source Drain Diode Forward Voltage



Drain Source Breakdown vs. Junction Temperature



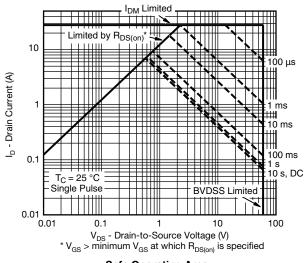
On-Resistance vs. Gate-to-Source Voltage



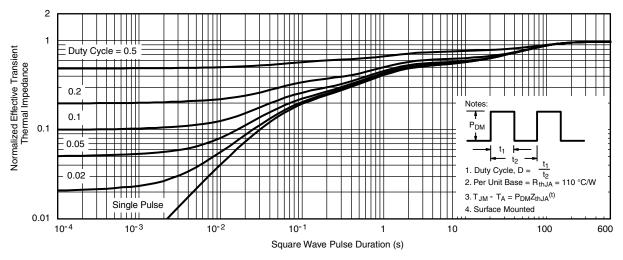
Threshold Voltage



THERMAL RATINGS ($T_A = 25$ °C, unless otherwise noted)



Safe Operating Area



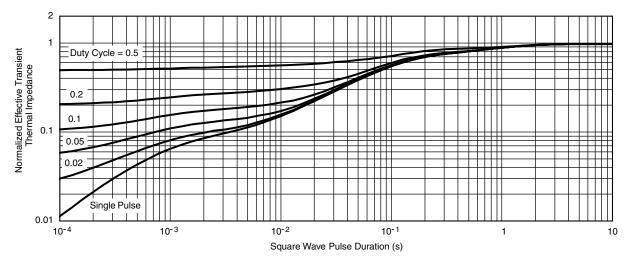
Normalized Thermal Transient Impedance, Junction-to-Ambient

服务热线:400-655-8788

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THERMAL RATINGS ($T_A = 25$ °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Foot



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